



<b>Form Type</b>	Distribute	<b>Version</b>	2.0	<b>Ref</b>	IPC 1752A	<b>Sectionals</b>	Material Info	<b>Subsectionals</b>	D, A
<b>Supplier Information</b>									
<b>Company Name</b>	TE Connectivity	<b>Request Document ID</b>		<b>Contact Name</b>	John R. Penica	<b>Contact Title</b>	Mgr. Global Product Compliance		
<b>Company Unique ID</b>	TE Connectivity	<b>Response Date</b>	2015-11-29	<b>Contact Email</b>	jrpenica@te.com				
<b>Contact Phone Number</b>	717-592-3266								
<b>Legal Statement</b>									
<b>Supplier Acceptance</b>	true								
<b>Legal Statement</b>									
The information provided in this document is based upon reasonable inquiry of our suppliers. This information is subject to change. This information does not in any way modify existing purchase specifications or existing contractual or other agreements terms between TE Connectivity (or its affiliated companies) and its customers.									
<b>Product</b>									
<b>Manufacturer Item number</b>	104069-1	<b>Amount</b>	1152.41899	<b>Version</b>	-	<b>Identity</b>			
<b>Manufacturer Item Name</b>	20 SYSTEM 50 HDR DRRR SHR D	<b>Weight Uom</b>	mg	<b>Mfr Site</b>		<b>Authority</b>			
<b>Date</b>		<b>UOM</b>	Each						
<b>EUroHS-0508</b>	Product(s) does not meet EU RoHS requirements and is not under exemptions								
<b>ChinaRoHS-0508</b>	Product(s) is NOT eligible for marking with the e code under China's Measures for Administration of the control of pollution by Electronic Information Products								
<b>EUREACH-1214</b>	REACH Candidate Substances of Very High Concern ARE NOT Contained in the Product Above the Limits per the Definition within REACH								
<b>Product Disclosure</b>									
<b>Sub-Item/Material/Substance</b>	<b>Level</b>	<b>Name</b>	<b>Substance Category</b>	<b>Substance CAS</b>	<b>Substance Concentration</b>	<b>Quantity</b>	<b>Mass per Unit</b>	<b>UOM</b>	<b>Exemption</b>
Sub-Item	1	SYSTEM 50 POST PLTD 30 DPLX				10.0	12.39179	mg	
Material	2	Nickel Plate				10.0	0.004413	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	10.0	1.0E-5	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.1	10.0	1.0E-5	mg	
Substance	3	Nickel	Nickel	7440-02-0	99.7	10.0	0.00439976	mg	
Material	2	Gold Plate				10.0	0.01032	mg	
Substance	3	Gold	Supplier	7440-57-5	99.7	10.0	0.01028904	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-0909	0.3	10.0	3.096E-5	mg	
Material	2	Brass				10.0	12.222187	mg	
Substance	3	Tin	Supplier	7440-31-5	0.1	10.0	0.01222219	mg	
Substance	3	Copper	Supplier	7440-50-8	64.0	10.0	7.8222	mg	
Substance	3	Iron	Supplier	7439-89-6	0.05	10.0	0.00611109	mg	
Substance	3	Beryllium	Supplier	7440-41-7	0.0010	10.0	1.2222E-4	mg	
Substance	3	Arsenic	Supplier	7440-38-2	0.01	10.0	0.00122222	mg	
Substance	3	Cobalt	Supplier	7440-48-4	0.1	10.0	0.01222219	mg	
Substance	3	Manganese	Supplier	7439-96-5	0.1	10.0	0.01222219	mg	
Substance	3	Zinc	Supplier	7440-66-6	35.2085	10.0	4.30325	mg	
Substance	3	Antimony	Supplier	7440-36-0	0.01	10.0	0.00122222	mg	
Substance	3	Chromium	Supplier	7440-47-3	0.01	10.0	0.00122222	mg	
Substance	3	Aluminum	Supplier	7429-90-5	0.05	10.0	0.00611109	mg	
Substance	3	Nickel	Nickel	7440-02-0	0.3	10.0	0.03666656	mg	
Substance	3	Cadmium	Cadmium/Cadmium Compounds	7440-43-9	0.01	10.0	0.00122222	mg	
Substance	3	Mercury	Mercury/Mercury Compounds	7439-97-6	5.0E-4	10.0	6.111093E-5	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.05	10.0	0.00611109	mg	
Material	2	Tin-Lead Plate				10.0	0.149	mg	
Substance	3	Tin	Supplier	7440-31-5	92.3	10.0	0.13753	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.7	10.0	0.001043	mg	

Substance	3	Lead	Lead/Lead Compounds	7439-92-1	7.0	10.0	0.01043	mg	
Material	2	Gold Plate				10.0	0.00587	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.3	10.0	1.761E-5	mg	
Substance	3	Gold	Supplier	7440-57-5	99.7	10.0	0.00585239	mg	
Sub-Item	1	SYSTEM 50 SDR CLIP 150 SN-PB				2.0	33.0005	mg	
Material	2	Nickel Plate				2.0	0.9965	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	2.0	0.001993	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.1	2.0	9.965E-4	mg	
Substance	3	Nickel	Nickel	7440-02-0	99.7	2.0	0.99351	mg	
Material	2	Phos Bronze				2.0	29.744	mg	
Substance	3	Copper	Supplier	7440-50-8	94.6985	2.0	28.16712	mg	
Substance	3	Manganese	Supplier	7439-96-5	0.02	2.0	0.0059488	mg	
Substance	3	Chromium	Supplier	7440-47-3	0.01	2.0	0.0029744	mg	
Substance	3	Tin	Supplier	7440-31-5	4.5	2.0	1.33848	mg	
Substance	3	Arsenic	Supplier	7440-38-2	0.0050	2.0	0.0014872	mg	
Substance	3	Iron	Supplier	7439-89-6	0.1	2.0	0.029744	mg	
Substance	3	Antimony	Supplier	7440-36-0	0.01	2.0	0.0029744	mg	
Substance	3	Beryllium	Supplier	7440-41-7	0.0010	2.0	2.9744E-4	mg	
Substance	3	Zinc	Supplier	7440-66-6	0.3	2.0	0.089232	mg	
Substance	3	Phosphorus	Supplier	7723-14-0	0.1	2.0	0.029744	mg	
Substance	3	Cobalt	Supplier	7440-48-4	0.1	2.0	0.029744	mg	
Substance	3	Cadmium	Cadmium/Cadmium Compounds	7440-43-9	0.0050	2.0	0.0014872	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.05	2.0	0.014872	mg	
Substance	3	Nickel	Nickel	7440-02-0	0.1	2.0	0.029744	mg	
Substance	3	Mercury	Mercury/Mercury Compounds	7439-97-6	5.0E-4	2.0	1.4872E-4	mg	
Material	2	Tin-Lead Plate				2.0	2.26	mg	
Substance	3	Tin	Supplier	7440-31-5	92.3	2.0	2.08598	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.7	2.0	0.01582	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	7.0	2.0	0.1582	mg	
Sub-Item	1	20 SYSTEM 50 HDR HSG DR LATCH				1.0	822.5	mg	
Material	2	LCP-GF30				1.0	822.5	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-0506	1.0	1.0	8.225	mg	
Substance	3	Liquid Crystal Polymer - ISO 1043-1 Term LCP	Supplier	1043-1-LCP	67.959	1.0	558.96278	mg	
Substance	3	Glass, oxide, chemicals	Supplier	65997-17-3	30.0	1.0	246.75	mg	
Substance	3	Carbon black	Supplier	1333-86-4	1.0	1.0	8.225	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.041	1.0	0.33723	mg	
Sub-Item	1	SYSTEM 50 POST PLTD 30 DPLX				10.0	14.000009	mg	
Material	2	Nickel Plate				10.0	0.006619	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	10.0	1.3238E-5	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.1	10.0	1.0E-5	mg	
Substance	3	Nickel	Nickel	7440-02-0	99.7	10.0	0.00659914	mg	
Material	2	Gold Plate				10.0	0.01032	mg	
Substance	3	Gold	Supplier	7440-57-5	99.7	10.0	0.01028904	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-0909	0.3	10.0	3.096E-5	mg	
Material	2	Brass				10.0	13.8282	mg	
Substance	3	Tin	Supplier	7440-31-5	0.1	10.0	0.0138282	mg	

Substance	3	Copper	Supplier	7440-50-8	64.0	10.0	8.85005	mg	
Substance	3	Iron	Supplier	7439-89-6	0.05	10.0	0.0069141	mg	
Substance	3	Beryllium	Supplier	7440-41-7	0.0010	10.0	1.3828E-4	mg	
Substance	3	Arsenic	Supplier	7440-38-2	0.01	10.0	0.00138282	mg	
Substance	3	Cobalt	Supplier	7440-48-4	0.1	10.0	0.0138282	mg	
Substance	3	Manganese	Supplier	7439-96-5	0.1	10.0	0.0138282	mg	
Substance	3	Zinc	Supplier	7440-66-6	35.2085	10.0	4.8687	mg	
Substance	3	Antimony	Supplier	7440-36-0	0.01	10.0	0.00138282	mg	
Substance	3	Chromium	Supplier	7440-47-3	0.01	10.0	0.00138282	mg	
Substance	3	Aluminum	Supplier	7429-90-5	0.05	10.0	0.0069141	mg	
Substance	3	Nickel	Nickel	7440-02-0	0.3	10.0	0.0414846	mg	
Substance	3	Cadmium	Cadmium/Cadmium Compounds	7440-43-9	0.01	10.0	0.00138282	mg	
Substance	3	Mercury	Mercury/Mercury Compounds	7439-97-6	5.0E-4	10.0	6.9141E-5	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.05	10.0	0.0069141	mg	
Material	2	Tin-Lead Plate				10.0	0.149	mg	
Substance	3	Tin	Supplier	7440-31-5	92.3	10.0	0.13753	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.7	10.0	0.001043	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	7.0	10.0	0.01043	mg	
Material	2	Gold Plate				10.0	0.00587	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.3	10.0	1.761E-5	mg	
Substance	3	Gold	Supplier	7440-57-5	99.7	10.0	0.00585239	mg	